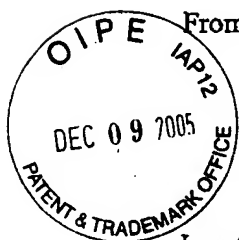


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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the Application of

TI-30110

Duy Q. Nguyen, et al.

Art Unit: 2664

Serial No.: 10/007,840

Examiner: Jamal A. Fox


Filed: October 30, 2001

Conf. No.: 7621

For: External Bus Arbitration Technique for Multicore DSP Device

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